Vishay Siliconix

SiS9122DN

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ISHA

Dual N-Channel 100 V (D-S) MOSFET



Top View

Bottom View

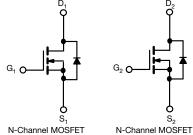
PRODUCT SUMMARY				
V _{DS} (V)	100			
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.160			
$R_{DS(on)}$ max. (Ω) at V_{GS} = 7.5 V	0.167			
Q _g typ. (nC)	2.9			
I _D (A) ^a	7.1			
Configuration	Dual			

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- 100 % R_q and UIS tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- DC/DC primary side switch
- Motor drive control
- Battery management
- Load switch



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK 1212-8 Dual
Lead (Pb)-free and halogen-free	SiS9122DN-T1-GE3

ABSOLUTE MAXIMUM RATING	(· A =, ·	T T		
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	100	V
Gate-source voltage		V _{GS}	± 20	v
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		7.1	
	T _C = 70 °C] , [5.7	
	T _A = 25 °C	I _D	2.5 ^{b, c}	
	T _A = 70 °C	1 1	2.0 ^{b, c}	•
Pulsed drain current (t = 100 µs)		I _{DM}	8	— A
Continuous source-drain diode current	T _C = 25 °C	I _S	7.1	
	T _A = 25 °C		1.9 ^{b, c}	
Single pulse avalanche current	L = 0.1 mH	I _{AS}	3	
Single pulse avalanche energy		E _{AS}	0.45	mJ
Maximum power dissipation	T _C = 25 °C		17.8	
	T _C = 70 °C		11.4	w
	T _A = 25 °C	PD	2.3 ^{b, c}	vv
	T _A = 70 °C	Τ Ι	1.48 ^{b, c}	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C
Soldering recommendations (peak temperature) ^c			260	-0

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b	t ≤ 10 s	R _{thJA}	43	54	°C/W	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	6	7.5		

Notes a. $T_C = 25 \ ^{\circ}C$

b. Surface mounted on 1" x 1" FR4 board

t = 10 s c.

See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 1212-8 Dual is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 94 °C/W d.

e. f.

S23-0551-Rev. A,10-Jul-2023



RoHS

COMPLIANT

HALOGEN

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	ц						
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	100	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA	-	84	-	m\//°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-6.4	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2	-	4	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20$	-	-	± 100	nA	
Zero gate voltage drain current		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1		
	I _{DSS}	V_{DS} = 100 V, V_{GS} = 0 V, T_J = 55 °C	-	-	10	μA	
Drain-source on-state resistance ^a	D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2.5 \text{ A}$	-	0.133	0.16	Ω	
	R _{DS(on)}	$V_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 2.0 \text{ A}$	-	0.139	0.167		
Forward transconductance ^a	9 _{fs}	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 2.5 \text{ A}$	-	7.0	-	S	
Dynamic ^b					•	•	
Input capacitance	C _{iss}	V_{DS} = 50 V, V_{GS} = 0 V, f = 1 MHz	-	210	-	pF	
Output capacitance	C _{oss}		-	28	-		
Reverse transfer capacitance	C _{rss}		-	6.2	-		
Total acta abarras	0	$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 2.0 \text{ A}$	-	3.8	6	nC	
Total gate charge	Qg		-	2.9	4.5		
Gate-source charge	Q _{gs}	V_{DS} = 50 V, V_{GS} = 7.5 V, I_{D} = 2.0 A	-	1.3	-		
Gate-drain charge	Q _{gd}		-	0.6	-		
Gate resistance	Rg	f = 1 MHz	0.7	1.5	2.5	Ω	
Turn-on delay time	t _{d(on)}		-	7	14		
Rise time	t _r	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 50 \text{ V}, \ R_{\text{L}} = 25 \ \Omega \\ I_{\text{D}} \cong 2 \text{ A}, \ V_{\text{GEN}} = 10 \ V, \ R_{\text{g}} = 1 \ \Omega \end{array}$	-	4	8		
Turn-off delay time	t _{d(off)}		-	10	20		
Fall time	t _f		-	3	6		
Turn-on delay time	t _{d(on)}		-	8	16	ns	
Rise time	t _r	$\begin{array}{l} V_{DD}=50~V,~R_L=25~\Omega\\ I_D\cong 2~A,~V_{GEN}=7.5~V,~R_g=1~\Omega \end{array}$	-	4	8	-	
Turn-off delay time	t _{d(off)}		-	10	20		
Fall time	t _f		-	3	6		
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	7.1	^	
Pulse diode forward current ($t_p = 100 \ \mu s$)	I _{SM}		-	-	8	A	
Body diode voltage	V _{SD}	I _S = 1.3 A	-	0.85	1.2	V	
Body diode reverse recovery time	t _{rr}		-	22	44	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 1.3 A, di/dt = 100 A/μs,	-	23	46	nC	
Reverse recovery fall time	t _a	$T_{\rm J} = 25 \ ^{\circ}{\rm C}$	-	19	-	ns	
Reverse recovery rise time	t _b		-	3	-		

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2



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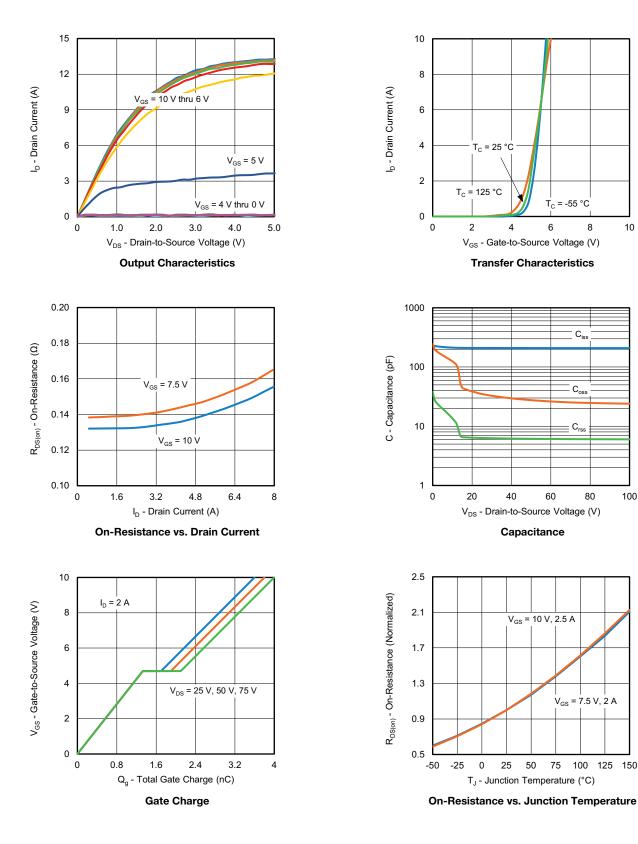
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80

100

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



S23-0551-Rev. A,10-Jul-2023

3

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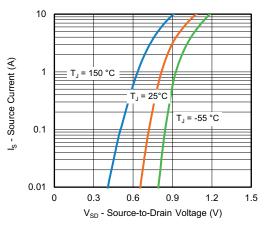
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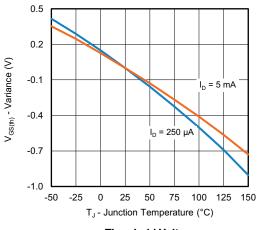
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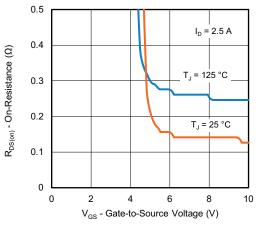
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



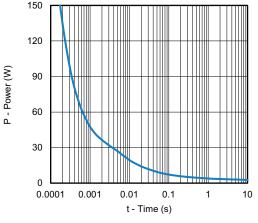
Source-Drain Diode Forward Voltage



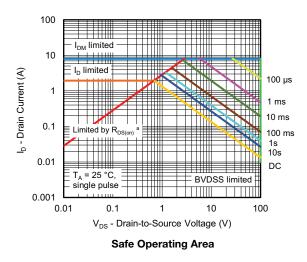




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Note

a. V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

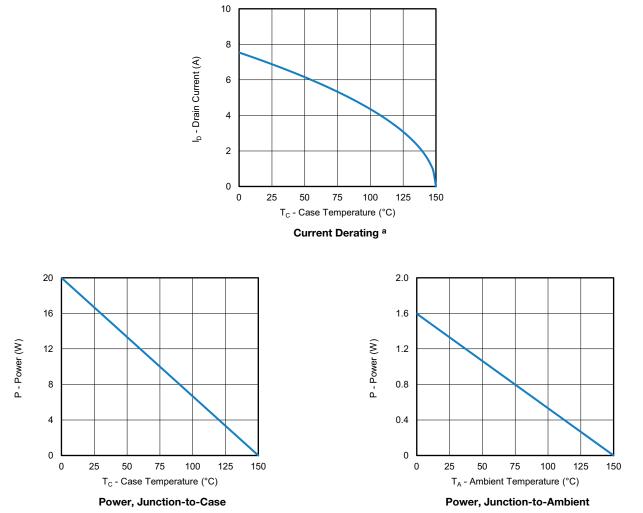
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note

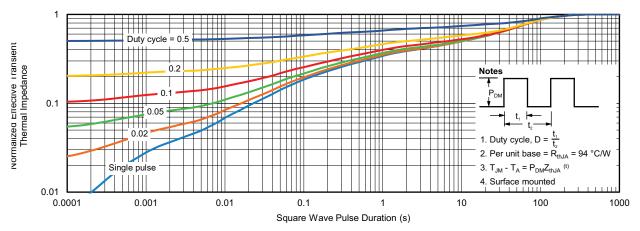
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



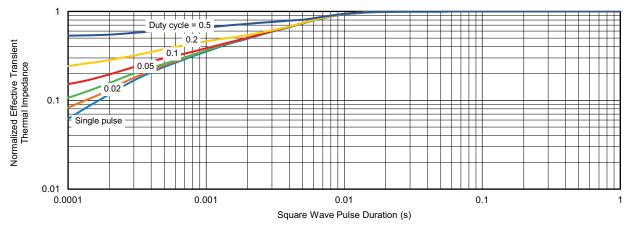
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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1